

1. 概述 INTRODUCTION

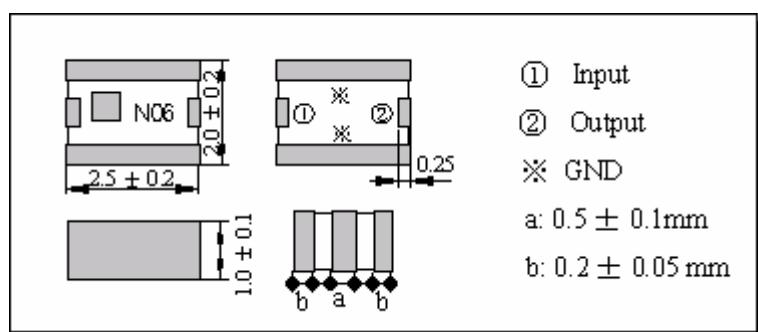
微波带通滤波器系列产品设计用于移动和无绳电话机中，具有低的插入损耗、高的衰减和小体积片式设计，能减少复杂的调校工作，可以简化电路设计。

Microwave Band-Pass filter series are designed to be used in mobile & cordless phones with low insertion loss and high attenuation as well as small size chip design , which can simplify your complex tunning and circuit design .

2. 型号 Part Number

LF	22	B2450	P57 - N06	标准规格，编号 N06/Norma Type: N06
				平面设计结构/Planar Design Series: P57
				带通滤波器/Band Pass Filter: 2450MHz
				产品尺寸/Size: 2.5×2.0×1.0
				多层结构滤波器/Multi-layer Filter

3. 外型尺寸 Dimensions (Unit: mm)



4. 结构及材料 Structure and Material

No	Part Name 名称	Structure and Material 结构及材料
4.1	Resonator 谐振体	Dielectric Material LTCC 介质材料
4.2	In/Output Terminals 输入/输出	Ag 银
4.3	Ground Base 接地面	Ag 银

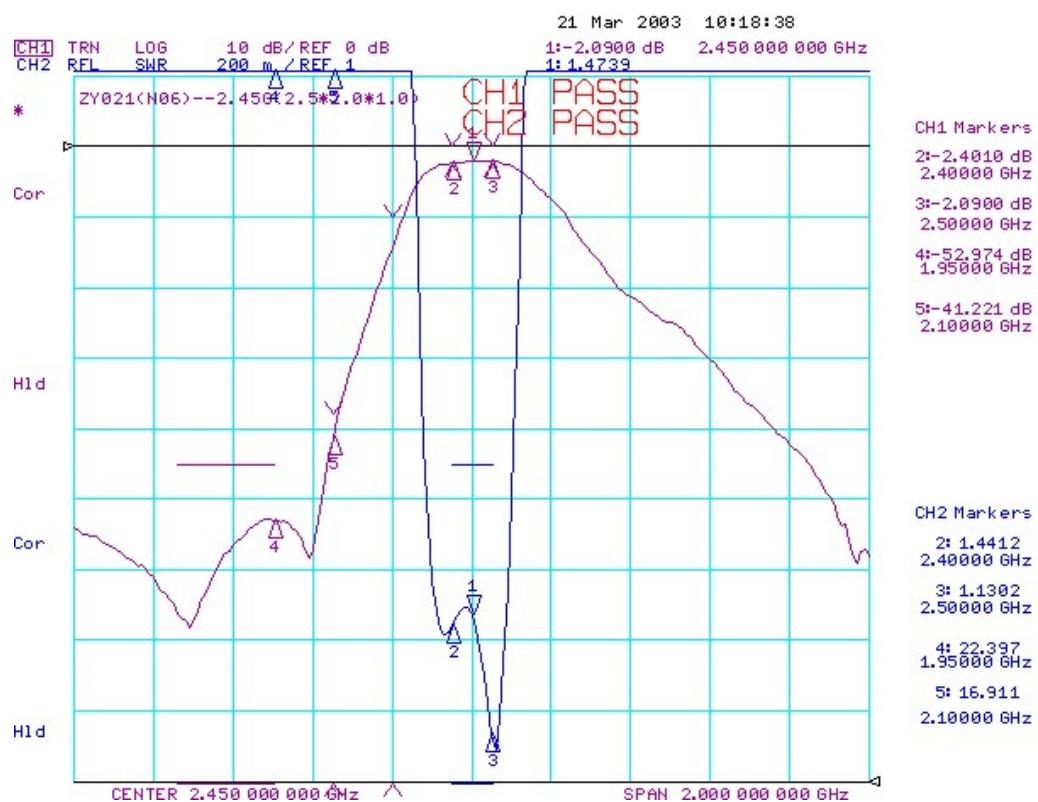
5. 电气性能

Electrical Characteristics

No.	Item (项目)	Specifications (特性)	Post Environmental Tolerance (环境试验后允许附加误差)
5.1	Center Frequency 中心频率 f_0	2450.00 MHz	± 5.0 MHz
5.2	Insertion Loss 插入衰耗	≤ 2.5 dB (at $-25^{\circ}\text{C} \pm 5^{\circ}\text{C}$)	± 0.5 dB
		≤ 3.0 dB (at $-40^{\circ}\text{C} \sim 85^{\circ}\text{C}$)	
5.3	Band Width 通带宽度	$f_0 \pm 50$ MHz	± 5.0 MHz
5.4	Ripple (in BW) 通带波动	≤ 1.0 dB	± 0.5 dB
5.5	V.S.W.R (in BW) 驻波比	≤ 2.0	± 0.2
5.6	Attenuation 阻带衰耗	≥ 45 (880~915MHz) ≥ 45 (1710~1950MHz) ≥ 35 (at 2100 MHz) ≥ 30 (4800~5000MHz) ≥ 38 (7200~7500MHz)	± 2.0 dB
5.7	Permissible Input Power (MAX)	0.5 W	—
5.8	In/Output Impedance 输入/输出阻抗	50 Ω	—

6. 特性曲线

Characteristic curve



7. 可靠性 Reliability: MTBF=1×10⁶/pc.hr

试验条件: 温度 Temperature: 40°C±5°C
负荷 Load: DC=5V±0.5V
数量 Quantity: 2000 pcs
持续时间 Sustained Time: 480 h

8. 环境试验 Environmental Test

经环境试验后允许比起始读数偏差见表 2

Post Environmental Tolerance (Refer to the table 2)

基准条件: 温度范围 Temperature range	25 ± 5 °C
相对湿度范围 Relative Humidity range	55~75%RH
工作温度 Operating Temperature range	-40°C~+85°C
贮藏温度 Storage Temperature range	-40°C~+85°C

8.1 耐振动 Vibration Resist

在振动频率为 10~55Hz 振幅为 1.5mm 沿 X.Y.Z 方向各振动 2 小时后测试符合表 5.1~5.6 规定。

The device should satisfy the electrical characteristics specified in paragraph 5.1~5.6 after applied to the vibration of 10 to 55Hz with amplitude of 1.5mm for 2 hours each in X, Y and Z directions.

8.2 耐跌落冲击 Drop Shock

在 100cm 高度处按 X, Y, Z 三个面分别自由跌落在木制地板上共 3 次后测试符合表 5.1~5.6 规定。

The device should satisfy the electrical characteristics specified in paragraph 5.1~5.6 after dropping onto the hard wooden board from the height of 100cm for 3 times each facet of the 3 dimensions of the device.

8.3 耐焊接热 Solder Heat Proof

能承受经 120~150°C 的温度预热 120 秒后, 在 230°C+10°C 的焊锡浸 5±0.5 秒。

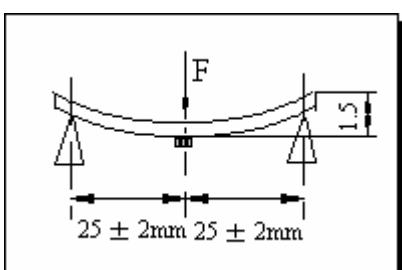
The device should be satisfied after preheating at 120°C~150°C for 120 seconds and dipping in soldering Sn at 230°C+5°C for 5±0.5 seconds.

8.4 结合力试验 Tensile Strength of Terminal

在产品电极端子上或表面上应能承受 1kg 垂直拉力 10±1 秒。

The device should not be broken after tensile force of 1.0kg is slowly applied to pull a lead pin of the fixed device in the lead axis direction for 10±1 seconds.

8.5 耐弯曲试验 Bending Resist Test



将产品按图焊在 1.6 ± 0.2mm 的 PCB 板中间,由箭头方向施力: 1mm/S, 弯曲距离: 1.5mm, 保持 5±1S, 产品金属层无脱落。

Weld the product to the center part of the PCB with the thickness $1.6 \pm 0.2\text{mm}$ as the illustration shows, and keep exerting force arrow-ward on it at speed of :1mm/S , and hold for $5 \pm 1\text{S}$ at the position of 1.5mm bending distance , so far , any peeling off of the product metal coating should not be detected .

8. 6 耐湿热特性 **Moisture Proof**

在温度为 $60 \pm 2^\circ\text{C}$, 相对湿度 90~95% 的恒温湿箱中放置 96 小时 , 在常温中恢复 1~2 小时后测试 , 符合表 5.1~5.6 规定。

The device should satisfy the electrical characteristics specified in paragraph 5.1~5.6 after exposed to the temperature $60 \pm 2^\circ\text{C}$ and the relative humidity 90~95% RH for 96 hours and 1~2 hours recovery time under normal condition.

8. 7 高温特性 **High Temperature Endurance**

在温度为 $85 \pm 5^\circ\text{C}$ 的恒温箱中放置 24 ± 2 小时 , 在常温中恢复 1~2 小时后测试。符合表 5.1~5.6 规定。

The device should satisfy the electrical characteristics specified in paragraph 5.1~5.6 after exposed to temperature $85 \pm 5^\circ\text{C}$ for 24 ± 2 hours and 1~2 hours recovery time under normal temperature.

8. 8 低温特性 **Low Temperature Endurance**

在温度为 $-40^\circ\text{C} \pm 5^\circ\text{C}$ 低温箱中放置 24 ± 2 小时后恢复 1~2 小时测试符合表 5.1~5.6 规定。

The device should also satisfy the electrical characteristics specified in paragraph 5.1~5.6 after exposed to the temperature $-40^\circ\text{C} \pm 5^\circ\text{C}$ for 24 ± 2 hours and to 2 hours recovery time under normal temperature.

8. 9 温度循环 **Temperature Cycle Test**

在 -25°C 温度中保持 30 分钟 , 再在 $+85^\circ\text{C}$ 温度中保持 30 分钟 , 共循环 5 次后在常温中恢复 1~2 小时后测试符合表 5.1~5.6 规定。

The device should also satisfy the electrical characteristics specified in paragraph 5.1~5.6 after exposed to the low temperature -25°C and high temperature $+85^\circ\text{C}$ for 30 ± 2 min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

9. 回流焊温度 **Reflow Soldering Standard Condition**

